02-09-20	06
FORM PTC_4595 (Modified) (Rev. 03-0-7) OMB No. 0651-0C27 (exp.5/31/2002) P08A/REV03	HEET U.S. DEPARTMENT OF COMMERCE
Tab settings → → ▼ 10317493	36 × 2.1 11 V × V
	ce: Please record the attached original documents or copy thereof.
Keiichi Nakamura Hajime Kawase Ryotaro Ishikawa Yutaka Noro Yutaka Kobayashi	2. Name and address of receiving party(ies): Name: Sumitomo Wiring Systems, Ltd. Address: 1-14, Nishisuehiro-cho
	1100
3. Nature of conveyance:	
🗵 Assignment 🗆 Merger	
	City: Yokkaichi-City State/Prov.: Mie
☐ Other	Country: Japan ZIP: 510-8503
Execution Date: January 26, 2006	Additional name(s) & address(es)
Patent Application No. Filing date 02/08/2006 BBYRNE 00000301 031030 11344649 01 FC:8021 40.00 DA Additional numbers	B. Patent No.(s)
	6. Total number of applications and patents involved:
concerning document should be mailed:	c. Total Hamber of applications and patents involved.
Name: Gerald E. Hespos Registration No. 30,066 Address: 274 Madison Avenue - Suite 1703	7. Total fee (37 CFR 3.41):\$ 40.00 □ Enclosed - Any excess or insufficiency should be credited or debited to deposit account
	Authorized to be charged to deposit account
	Authorized to be charged to deposit account B. Deposit account number:
	8. Deposit account number:
City: New York State/Prov.: NY	8. Deposit account number: 03-1030
City: New York State/Prov.: NY Country: USA ZIP: 10016	8. Deposit account number: 03-1030 (Attach duplicate copy of this page if paying by deposit account)
City: New York State/Prov.: NY Country: USA ZIP: 10016 DO NOT 9. Statement and signature.	8. Deposit account number: 03-1030

Mail documents to be recorded with required cover sheet information to:
Mail Stop Assignment Recordation Services
Director of the United States Patent and Trademark Office
P.O. Box 1450, Alexandria, VA 22313-1450

Docket No.: FP05-330US

Atty. Ref.: FP05-330US

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignee, Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "A MALE TERMINAL FITTING AND A BLANK THEREFOR", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries at its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patents which may be granted therefor in said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patents to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner Of Patents is Hereby Authorized And Requested to issue any and all Letters Patent of the United States for said invention, to said assignee.

Jan. 26. 2006	Keiichi hakumura
Date	Keiichi Nakamura
Tan 26, 2006	Ryotaro Solipana Ryotaro Ishikawa
Date	
Jan 26, 2006 Date	Yutaka Noro
Date	Yutaka Noro
Jan 26.2006	<u> Juliaka Kakouni Shu</u> Yutaka Kobayashi
Date	Yutaka Kobayashi 💚 🗸 🤫
Jan. 26. 2006	Hajime Kaunse Hajime Kawase
Date	Hajime Kawase

PATENT REEL: 017536 FRAME: 0938

RECORDED: 02/01/2006